



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	ISZ3XXN10NM6	<b>Issued</b>	07. February 2022
<b>MA#</b>	MA005403015		
<b>Package</b>	PG-TSDSON-8-25	<b>Weight*</b>	35.44 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.318	0.90	0.90	8969	8969
leadframe	inorganic material	phosphorus	7723-14-0	0.002	0.01		69	
	non noble metal	zinc	7440-66-6	0.010	0.03		278	
	non noble metal	iron	7439-89-6	0.197	0.56		5551	
	non noble metal	copper	7440-50-8	7.988	22.54	23.14	225381	231279
wire	noble metal	gold	7440-57-5	0.027	0.08	0.08	762	762
encapsulation	organic material	carbon black	1333-86-4	0.038	0.11		1075	
	plastics	epoxy resin	-	1.961	5.53		55338	
	inorganic material	silicondioxide	60676-86-0	17.043	48.06	53.70	480849	537262
leadfinish	non noble metal	tin	7440-31-5	0.395	1.12	1.12	11152	11152
plating	noble metal	silver	7440-22-4	0.020	0.06	0.06	573	573
solder	non noble metal	tin	7440-31-5	0.010	0.03		277	
	noble metal	silver	7440-22-4	0.012	0.03		346	
	non noble metal	lead	7439-92-1	0.469	1.32	1.38	13228	13851
heat sink clip	inorganic material	phosphorus	7723-14-0	0.001			26	
	non noble metal	zinc	7440-66-6	0.004	0.01		103	
	non noble metal	iron	7439-89-6	0.073	0.21		2056	
	non noble metal	copper	7440-50-8	2.959	8.35	8.57	83489	85674
heatspreader	inorganic material	phosphorus	7723-14-0	0.001			33	
	non noble metal	zinc	7440-66-6	0.005	0.01		133	
	non noble metal	iron	7439-89-6	0.094	0.27		2651	
	non noble metal	copper	7440-50-8	3.816	10.77	11.05	107661	110478
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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